BGF109C

10 Channel LCD Filter Array with ESD Protection

Small Signal Discretes



Edition 2008-08-05

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BGF109	С
Revisio	n History: 2008-08-05, V2.0
Previou	s Version: 2008-07-17, V1.0
Page	Subjects (major changes since last revision)
All	Preliminary status removed



10 Channel LCD Filter Array with ESD Protection

Feature

- · 10 channel integrated RC filter array
- ESD protection according to IEC61000-4-2 up to 15 kV contact discharge on all IOs
- Wafer Level Package with SnAgCu solder balls
- RoHS and WEEE compliant package
- · Improved package for increased drop test reliability





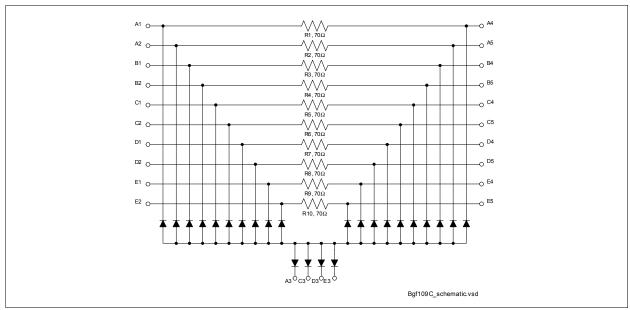


Figure 1 Schematic

Description

The BGF109C is a 10 channel RC filter array to provide attenuation of undesired signals in the 800 - 2000 MHz range. All pins are protected against ESD up to 15 kV according to IEC61000-4-2 (contact discharge). The wafer level package is a green package with a size of only $1.95 \text{ mm} \times 2.07 \text{ mm}$ and a total height of 0.60 mm. The package has been improved for increased drop test reliability.

Туре	Package	Marking	Chip
BGF109C	WLP-24-9	BGF109C	N0716



Table 1 Maximum Ratings

Parameter	Symbol	Values			Unit	Note /
		Min.	Тур.	Max.		Test Condition
Voltage at all pins to GND	V_{P}	-7		7	V	
Operating temperature range	T_{OP}	-40		+85	°C	
Storage temperature range	T_{STG}	-65		+150	°C	
Summed up input power for all pins	P_{IN}			60	mW	T _S < 70 °C
Electrostatic discharge according to IEC61000-4-2 ¹⁾ at all pins	V_{E}	-15		15	kV	

¹⁾ Contact discharge

Table 2 Electrical Characteristics¹⁾

Parameter	Symbol	Values			Unit	Note /
		Min.	Тур.	Max.		Test Condition
Series Resistors R_1 R_{10}	R	56	70	84	Ω	
Line capacitance of each line to GND	C_{T}		28 17	30	pF	$V_{R} = 0 \text{ V}$ $V_{R} = 3 \text{ V}$
Leakage currents of lines to GND	I_{R}			100	nA	V _R = 3 V

¹⁾ at $T_{A} = 25 \, ^{\circ}\text{C}$

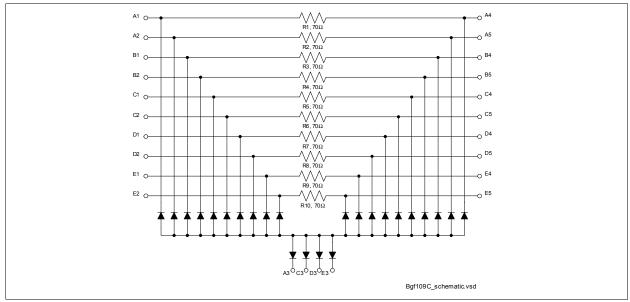


Figure 2 Schematic



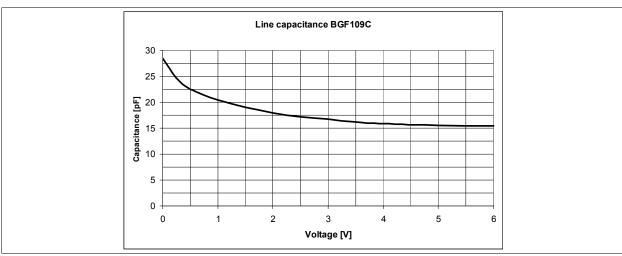


Figure 3 Capacitance of one line to GND versus DC voltage

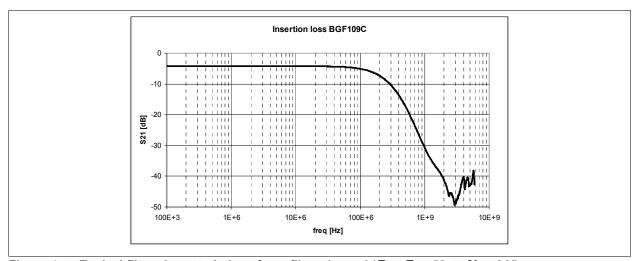


Figure 4 Typical filter characteristics of one filter channel ($Z_S = Z_L = 50 \Omega$, $V_R = 0 V$)

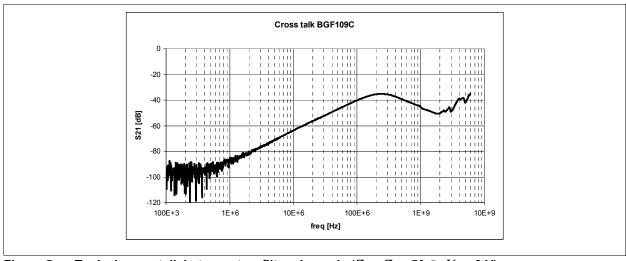


Figure 5 Typical cross talk between two filter channels ($Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω , $V_{\rm R}$ = 0 V)



Package Outline

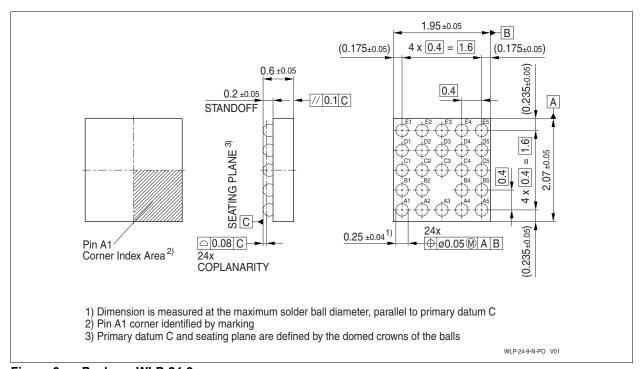


Figure 6 Package WLP-24-9

Tape and reel specification

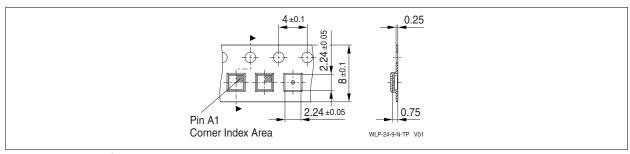


Figure 7 Tape for WLP-24-9